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CUSTOMER . PTC

SAMPLE CODE : SH102600T003-IBA

MASS PRODUCTION CODE . PH102600T003-IBA

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 001

DRAWING NO. (Ver.) . LMD-PH102600T003-IBA (Ver.001)

PACKAGING NO. (Ver.) · PKG-PH102600T003-IBA (Ver.001)

Customer Approved

Date:

Approved	Checked	Designer
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2013.12.23

TW RD APF

☐ Preliminary specification for design input

Specification for sample approval

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History of Version

Date	Ver.	Edi.	Description	Page	Design by
12/20/2013	01	001	New Sample.	-	Ackey
				<i></i>	

Total: 24 Page



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Appendix: LCM Drawing

LCM Packaging Specifications



1. SPECIFICATIONS

1.1 Features

Main LCD Panel

Item	Standard Value
Display Type	1024* (R · G · B) * 600 Dots
LCD Type	Normally white
Screen size(inch)	10.1(Diagonal)
Surface treatment	Anti-glare, Hard-Coating(3H)
Color configuration	R.G.B. vertical stripe
Backlight	White LED
Interface	LVDS
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	244.0(W) * 143.0 (L) * 12.4 (H)	mm

LCD panel

Item	Standard Value	Unit
Active Area	222.72 (W) * 125.28 (L)	mm

Note: For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

Module

Item	Symbol	Min.	Max.	Unit	
Overally Maltage	V.	-0.3	3.6	V	Logic power supply voltage
Supply Voltage	V_{IN}	-0.3	24	V	LED Driver Vin
Power Supply Fuse Current Setting	I _{FUSE}	-	1.5	Α	Vin from 10%~90%,rise time 500us
Input Signal	Vs	-	3.6	V	LVDS signals
PWM Voltage	V_{PWM}	0.8	5.0	V	PWM Dimming Voltage
Operating Temperature	TOP	-30	85	°C	
Operating Humidity	HOP	10	85	%RH	
Storage Temperature	TST	-30	85	°C	(1)
Storage Humidity	HST	10	85	%RH	

Note:

(1) The storage /operating temperature. Maximum Wet-Bulb should be 39 degree C. There is no condensation on the panel surface.





1.4 DC Electrical Characteristics

System Power Supply

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Input Power Supply Voltage	V _{IN}	3.0	3.3	3.6	٧	
Input Power Supply Current	I _{VIN}	-	-	191	mA	Black pattern 60Hz
Input Inrush Current	I _{RUSH}	1	-	1.5	Α	0.5ms rise time(10%~90%)
Input Power Voltage Ripple	V_{RPL}	-	-	200	mV	V_{P-P}
REV	VH	2.0	3.3	5.0	V	-
NEV	VL	-	-	0.8	٧	-

LED Power Supply

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Input Power Supply Voltage	V _{LED-IN}	8	12	16	٧	
Input Power Supply Current	I _{IN}	-	-/	546	mA	
EN/PWM	VH	2.0	3.3	5.0	V	
EIN/PVVIVI	VL	-	-	0.8	V	

LVDS Signals

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Differential Input High Threshold	V_{th}	-	-	+100	mV	V _{cm} =+1.2v
Differential Input High Threshold	V _{tl}	-100	-	-	mV	V _{cm} =+1.2v
Magnitude Differential Input Voltage	[V _{id}]	200	-	600	mV	
Common Mode Voltage	V _{cm}	1.0	1.2	1.4	V	$V_{th} - V_{tl} = 200 \text{mV}$
Common Mode Voltage Offset	$\triangle V_{cm}$	-50	-	+50	mV	V _{th} - V _{tl} = 200mV



1.5 Optical Characteristics

TFT LCD Panel

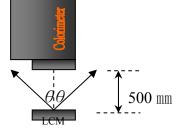
VDD=3.3V, Ta=25°C

Item		Symbol	Condition	Min.	Тур.	Max.	Unit	-
Response tin	ne	Tr + Tf	Ta = 25°C θX, θY = 0°	-	16	20	ms	Note2
	Тор	θΥ+		70	80	-		
Viewing angle	Bottom	θΥ-	CR ≥ 10	70	80	-	Dog	Note4
viewing angle	Left	θX-	CR 2 10	70	80	-	Deg.	Note4
	Right	θX+		70	80	-		~
Contrast rati	О	CR		400	500	-	-	Note3
	White	Χ		0.255	0.305	0.355		
	VVIIILE	Υ		0.275	0.325	0.375		
0 1 (0)5	Red	Х	Ta = 25°C	0.529	0.579	0.629		
Color of CIE Coordinate		Υ		0.294	0.344	0.394		Note1
(With B/L)	Croon	Х	θX , $\theta Y = 0^{\circ}$	0.276	0.326	0.376	-	Note
(**************************************	Green	Υ		0.541	0.591	0.641		
	Dlug	Х		0.109	0.159	0.209		
	Blue	Υ		0.081	0.131	0.181		
Average Brightness Pattern=white display		IV		400	500	-	cd/m ²	Note1
Uniformity		В		75	_	-	%	Note1

Note1:

- 1: $B=B(min) / B(max) \times 100\%$
- 2 : Measurement Condition for Optical Characteristics:
 - a: Environment: 25 ±5 / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b : Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta = 0^{\circ})$
 - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
 - d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





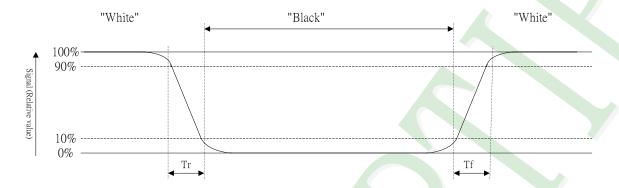
Colorimeter=BM-7 fast



Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:



Note3: Definition of contrast ratio:

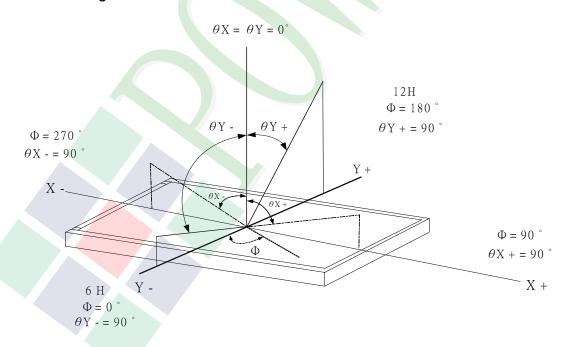
Contrast ratio is calculated with the following formula

Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle: Refer to figure as below:





1.6 Backlight Characteristics

Ite	Item		MIN	TYP	MAX	CONDITION
VIN_	_LED	V	8	12	16	DUTY=100%
V _{VIN}	N_LED	mA	1	1	543	-
F	DIM	HZ	100	1	1K	-
DU	DUTY		5	-	100	-
CTRL	VIH	V	2	3.3	5	-
CIRL	VIL	V	0	-	0.8	-
Vo	V _{OUT}		-	22.4	-	-
Ic	I _{OUT}		-	160	-	-
L _T		Hours	50,000	-	-	LED Life Time

Note: The LED life time define as the estimated time to 50% degradation of initial luminous.

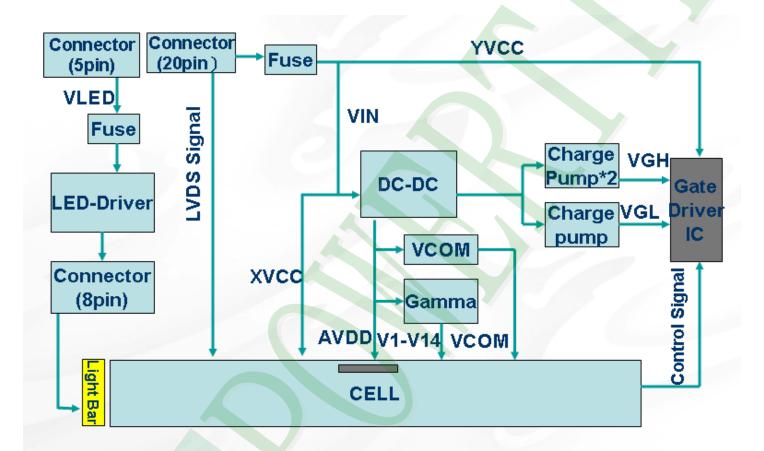




2. MODULE STRUCTURE

2.1 Counter Drawing

- 2.1.1 LCM Mechanical Diagram
 - * See Appendix
- 2.1.2 Block Diagram





2.2 Interface Pin Description(CN1)

Pin No.	Symbol	Description	
1	VDD	Power Supply.3.3V (typical)	-
2	VDD	Power Supply.3.3V (typical)	-
3	VSS	Ground.	-
4	REV	Reverse Scan selection.	-
5	Rin 1-	-LVDS differential data input	-
6	Rin 1+	+LVDS differential data input	-
7	VSS	Ground.	-
8	Rin 2-	-LVDS differential data input.	-
9	Rin 2+	+LVDS differential data input.	-
10	VSS	Ground.	-
11	Rin 3-	-LVDS differential data input.	-
12	Rin 3+	+LVDS differential data input.	-
13	VSS	Ground.	-
14	ClkIN-	-LVDS differential data input.	-
15	ClkIN+	+LVDS differential data input.	-
16	VSS	Ground.	-
17	NC	Not connection.	-
18	NC	Not connection.	-
19	VS <mark>S</mark>	Ground.	-
20	NC	Not connection.	High Active



B/L Pin Assignment(CN2)

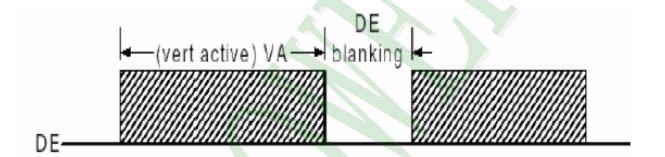
Pin No.	Symbol	Description	Remarks
1	VCC	Power Supply. 12V(typical).	
2	GND	Ground.	
3	EN	3.3V (typical)	-
4	PWM	3.3V (typical)	-
5	NC	Not Connection	/-



2.3 Timing Characteristics

DE Synchronization

Parameter	Symbol	Unit	Min.	Тур.	Max.
LVDS Clock Frequency <single></single>	f _{dck}	MHz	45	51.2	57
H Total Time	T _{hp}	clocks	1,324	1,344	1,364
H Active Time	HA	clocks	1,024	1,024	1,024
H Blanking Time	TH _{BLANK}	clocks	300	320	340
∨ Total Time	T _{vp}	lines	625	635	645
V Active Time	VA	lines	600	600	600
∨ Blanking Time	TV _{BLANK}	lines	25	35	45
∨ Frequency	f _v	Hz	55	60	65



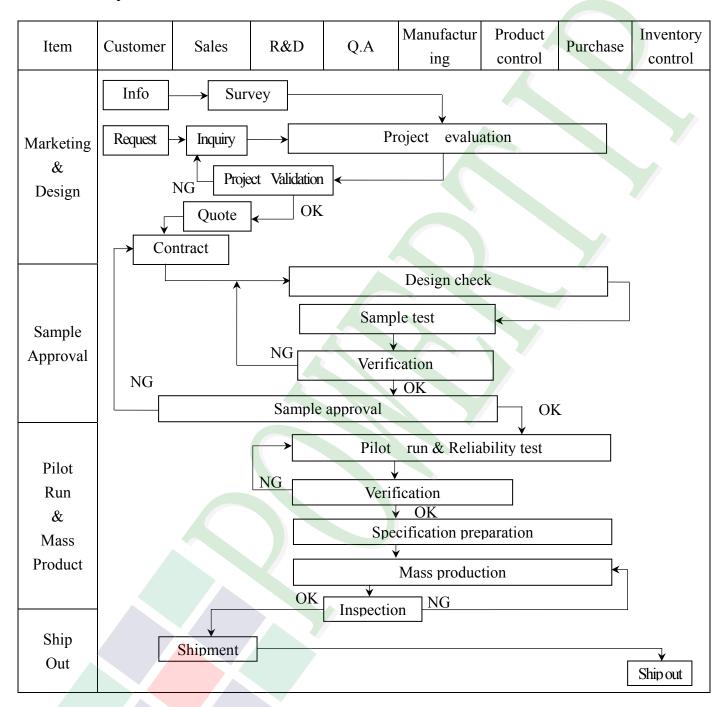
LVDS Data Mapping



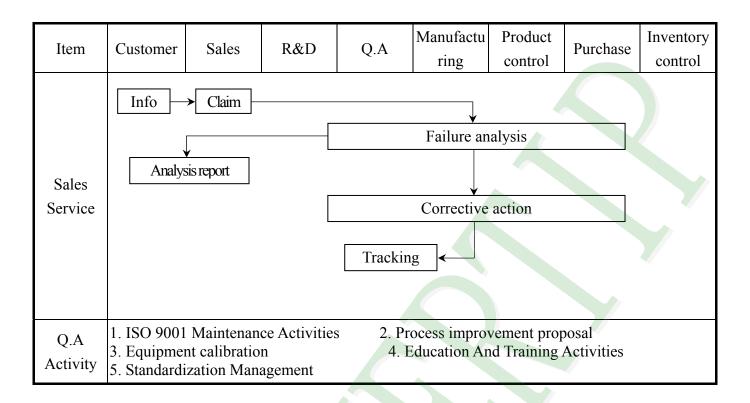


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2. Inspection Specification

Scope: The document shall be applied to TFT-LCD Module for 3.5" ~10.1" (Ver.B01).

Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level

Equipment : Gauge · MIL-STD · Powertip Tester · Sample

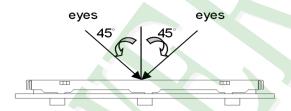
Defect Level: Major Defect AQL: 0.4; Minor Defect AQL: 1.5

OUT Going Defect Level: Sampling.

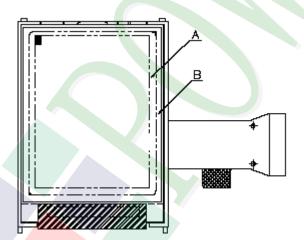
Standard of the product appearance test:

a. Manner of appearance test:

- (1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.
- (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



NO	Item	Criterion	Level	
		1.1The part number is inconsistent with work order of production.		
01	Product condition	1.2 Mixed product types.	Major	
		1.3 Assembled in inverse direction.	Major	
02	Quantity	2.1The quantity is inconsistent with work order of production.	Major	
03	Outline dimension	3.1 Product dimension and structure must conform to structure diagram.	Major	
		4.1 Missing line character and icon.	Major	
	Electrical Testing	4.2 No function or no display.		
04		4.3 Display malfunction.		
		4.4 LCD viewing angle defect.		
		4.5 Current consumption exceeds product specifications.	Major	
		Lann Assentance (Otto)		
		Item Acceptance (Q'ty) Bright Dot 4		
		Doub Dot		
	Dot defect	Dot Dark Dot 5 Defect Joint Dot 3		
	(Bright dot \	Total 7		
05	Dark dot)		Minor	
	On -display	5.1 Inspection pattern: full white, full black, Red, Green and		
	on unspiny	blue screens.		
		5.2 It is defined as dot defect if defect area >1/2 dot.		
		5.3 The distance between two dot defect ≥5 mm.5.4 Bright dot that can be seen through 5% ND filter.		
		3.4 Dirgit dot that can be seen through 5% ND Tiller.		



NO	Item	Criterion				
		6.1 Round type (Non-display or display):				
		Dimension (diameter : Φ) Acceptance (Q'ty) A area B area				
	Black or white dot \(\cdot \) scratch \(\cdot \)	Ф 0.25 Ignore				
	contamination Round type	0.25 < Φ 0.50 5				
	→ X ← T	Φ > 0.50				
06	Round type X Y Y	Total 5	Minor			
00	$\Phi = (x+y)/2$	6.2 Line type(Non-display or display):	Minor			
	Line type	Length (L) Width (W) Acceptance (Q'ty) A area B area				
	✓ † W	W 0.03 Ignore				
	→ L I←	L 10.0 0.03 < W 0.05 4 L 5.0 0.05 < W 0.10 2 Ignore				
		$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				
		Total 5				
		Dimension (diameter : Φ) Acceptance (Q'ty)				
		Φ 0.25 Ignore				
07	Polarizer Bubble	$0.25 < \Phi$ 0.50 4	Minor			
	Bubble	$0.50 < \Phi $				
		Total 5				



NO	Item	Criterion	Criterion		
		Z: The thickness of crack	Y: The width of crack. W: terminal length a: LCD side length		
		8.1 General glass chip: 8.1.1 Chip on panel surface and cra	ack between panels:		
		Z	Z X		
08	The crack of glass	SP Y (OK)	[NG]	Minor	
		Seal width Z	Y		
		X Y	Z		
		a Crack can't enter viewing area	1/2 t		
		a Crack can't exceed the half of SP width.	1/2 t < Z 2 t		



NO	Item	Criterion	Level				
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8.1.2 Corner crack:					
		X Y Z 1/5 a Crack can't enter viewing area Z 1/2 t					
		1/5 a Crack can't exceed the half of SP width. 1/2 t < Z 2 t					
08	The crack of glass	8.2 Protrusion over terminal: 8.2.1 Chip on electrode pad: X Y Z	Minor				
		W Y W W					
4		$\begin{array}{c cccc} X & Y & Z \\ \hline Front & a & \leq 1/2 W & \leq t \end{array}$					
		Back a ≤ W ≤ 1/2 t					



NO	Item	Criterion		
NO	The crack of glass	Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8.2.2 Non-conductive portion: X X Y Z 1/3 a W t O If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. 8.2.3 Glass remain:	Minor	



NO	Item	Criterion	Level
		9.1 Backlight can't work normally.	Major
09	Backlight elements	9.2 Backlight doesn't light or color is wrong.	Major
		9.3 Illumination source flickers when lit.	Major
		10.1 Pin type \quantity \dimension must match type in structure diagram.	Major
	General appearance	10.2 No short circuits in components on PCB or FPC.	Major
		10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts, missing parts or excess parts.	Major
10		10.4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10.5 The folding and peeled off in polarizer are not acceptable.	Minor
		10.6 The PCB or FPC between B/L assembled distance(PCB or FPC) is 1.5 mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

4.	Reliability lest Cond					
NO.	TEST ITEM	TEST CONDITION				
1	High Temperature Storage Test	Keep in +80 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.				
2	Low Temperature Storage Test	Keep in -30 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.				
3	High Temperature / High Humidity Storage Test	Keep in +60°C / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)				
4	Temperature Cycling Storage Test	$-30^{\circ}\text{C} \rightarrow +25^{\circ}\text{C} \rightarrow +80^{\circ}\text{C} \rightarrow +25^{\circ}\text{C}$ (30mins) (5mins) (30mins) (5mins)				
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance: 15°C ~35°C 2. Humidity relative: 30% ~60% 3. Energy Storage Capacitance(Cs+Cd): 150pF±10% 4. Discharge Resistance(Rd): 330 Ω±10% 5. Discharge, mode of operation: Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication: ±5%)				
6	Vibration Test (Packaged)	 Sine wave 10 55 Hz frequency (1 min) The amplitude of vibration :1.5 mm Each direction (X \ Y \ Z) duration for 2 Hrs 				
7	Drop Test (Packaged)	Packing Weight (Kg) Drop Height (cm) 0 ~ 45.4 122 45.4 ~ 90.8 76 90.8 ~ 454 61 Over 454 46 Drop direction : ※1 corner / 3 edges / 6 sides each 1 times				



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

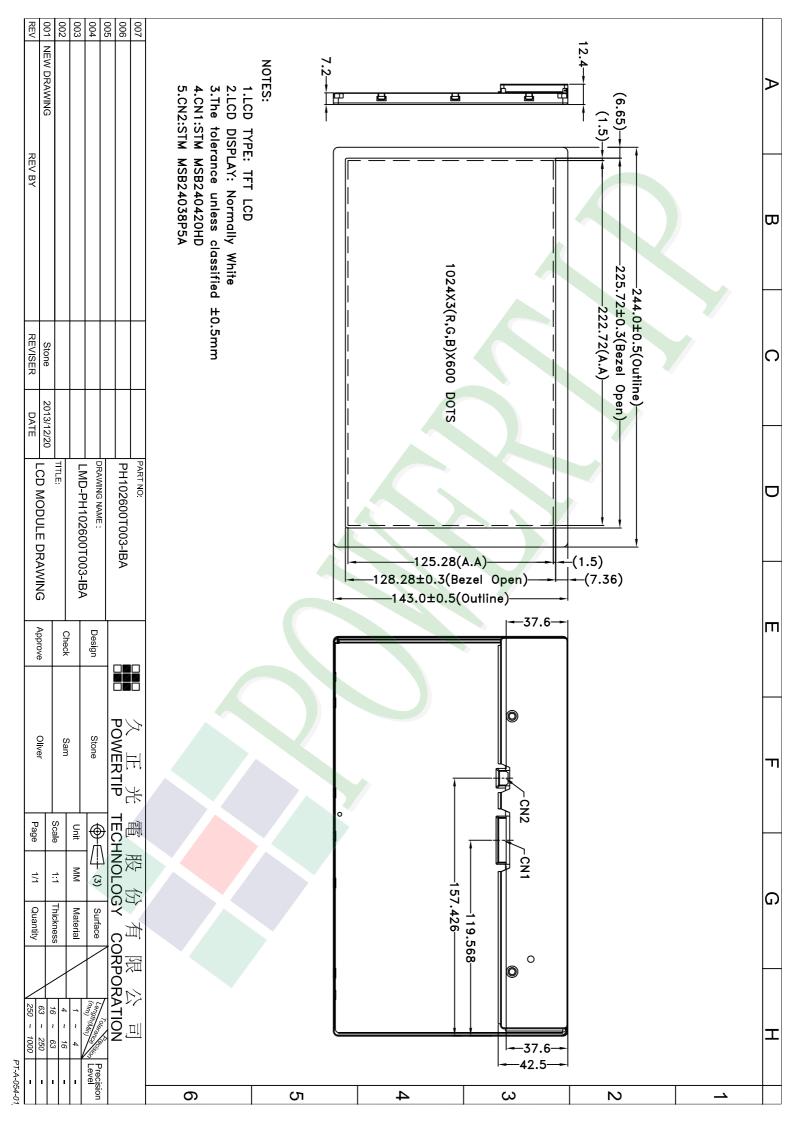
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully, do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $320 \pm 10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period
 - The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Ver	.001	ICM句	裝規格書		Approve	Check	Contact	
Doc	uments NO. PKG-PH102600T003-IB	Oliver	Sam	Stone				
1 右	1.包裝材料規格表 (Packaging Material): (per carton)							
No.	Item	Model	Dimensions (mm)	1Pcs	s Weight	Quantity	Total Weight	
1	成品 (LCM)	PH102600T003-IBA	244.0 X143.0	_		30		
2	靜電袋(1)Antistatic Bag			_		30		
3	紙塑包材上蓋(2)Paper Plastic			_		2		
4	紙塑包材底座(3)Paper Plastic			_		1		
5	外紙箱(4)Carton			_		1		
2 —	┗ 整箱總重量 (Total LCD Weight in c	erton): 14.47 Kg+10	00%					
	新華袋+LCM static Bag+LCM 新華學科底座 Paper Plastic	特記事	(4)外紙箱 Carton					
3. 使	用供應商原包材包裝。							